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ISL9K460P3 — STEALTH™ Dual Diode

# ISL9K460P3 8 A, 600 V, STEALTH™ II Diode

### Features

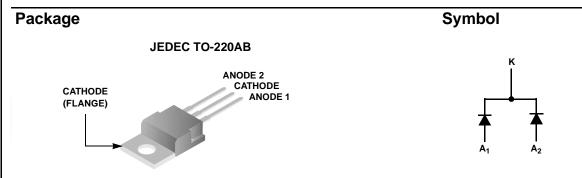
- Stealth Recovery  $t_{rr}$  = 17 ns (@  $I_F$  = 4 A)
- Max Forward Voltage,  $V_F$  = 2.4 V (@  $T_C$  = 25°C)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

### Applications

- SMPS FWD
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- Snubber Diode

### Description

The ISL9K460P3 is a STEALTH<sup>™</sup> dual diode optimized for low loss performance in high frequency hard switched applications. The STEALTH<sup>™</sup> family exhibits low reverse recovery current (I<sub>rr</sub>) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I<sub>rr</sub> and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH<sup>™</sup> diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

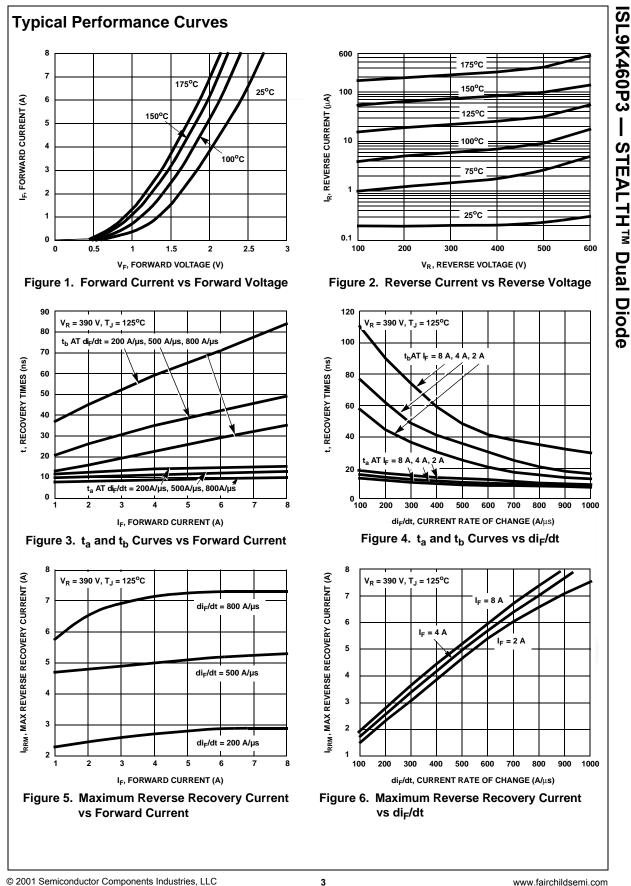


## Device Maximum Ratings (per leg) T<sub>C</sub>= 25°C unless otherwise noted

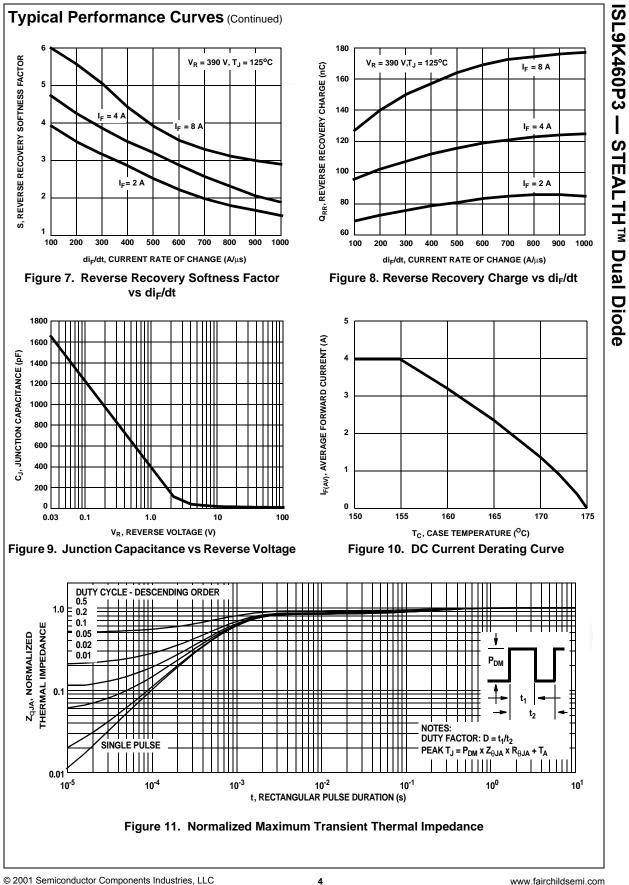
Symbol	Parameter	Rating	Unit
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	600	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V
V <sub>R</sub>	DC Blocking Voltage	600	V
I <sub>F(AV)</sub>	Average Rectified Forward Current (T <sub>C</sub> = 155°C)	4	A
	Total Device Current (Both Legs)	8	Α
I <sub>FRM</sub>	Repetitive Peak Surge Current (20kHz Square Wave)	8	Α
I <sub>FSM</sub>	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	50	Α
PD	Power Dissipation	58	W
E <sub>AVL</sub>	Avalanche Energy (0.5A, 80mH)	10	mJ
J, T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 175	°C
ΤL	Maximum Temperature for Soldering	300	°C
T <sub>PKG</sub>	Leads at 0.063in (1.6mm) from Case for 10s	260	°C
	Package Body for 10s, See Techbrief TB334		

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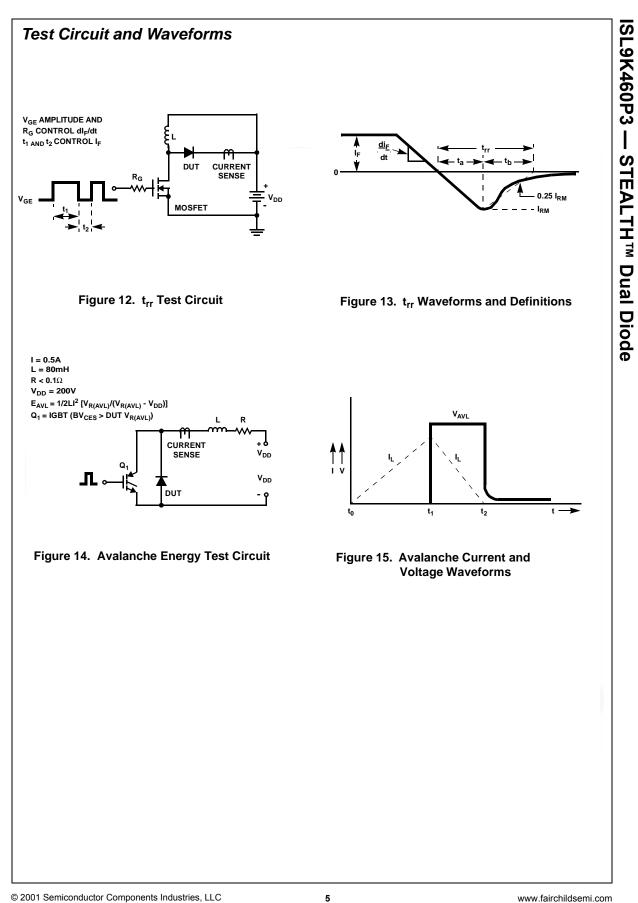
Parameter teristics eous Reverse Current teristics eous Forward Voltage teristics Capacitance teteristics Recovery Time	Test C $V_{R} = 600 V$ $V_{R} = 600 V$ $I_{F} = 4 A$ $V_{R} = 10 V, I_{F} = 0$ $I_{F} = 1 A, di_{F}/dt =$	onditions $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$	Min           -           -           -           -           -           -           -           -           -           -	//A <b>Typ</b> - - 2.0 1.6 19	Max 100 1.0 2.4 2.0	50 Unit μΑ mA V V
Parameter teristics eous Reverse Current teristics eous Forward Voltage teristics Capacitance teteristics Recovery Time	Test C $V_R = 600 V$ $I_F = 4 A$ $V_R = 10 V, I_F = 0$ $I_F = 1 A, di_F/dt =$	onditions $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$	Min - - - -	- - 2.0 1.6	100 1.0 2.4	μA mA V
eteristics eous Reverse Current teristics eous Forward Voltage eteristics Capacitance acteristics Recovery Time	$V_{R} = 600 V$ $I_{F} = 4 A$ $V_{R} = 10 V, I_{F} = 0$ $I_{F} = 1 A, di_{F}/dt =$	$T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$	Min	- - 2.0 1.6	100 1.0 2.4	μA mA V
eous Reverse Current teristics eous Forward Voltage teristics Capacitance teteristics Recovery Time	I <sub>F</sub> = 4 A V <sub>R</sub> = 10 V, I <sub>F</sub> = 0	$T_{C} = 125^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$		1.6	1.0 2.4	mA V
eteristics eous Forward Voltage eteristics Capacitance acteristics Recovery Time	I <sub>F</sub> = 4 A V <sub>R</sub> = 10 V, I <sub>F</sub> = 0	$T_{C} = 125^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$		1.6	1.0 2.4	mA V
eous Forward Voltage teristics Capacitance acteristics Recovery Time	V <sub>R</sub> = 10 V, I <sub>F</sub> = 0	$T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$		1.6	2.4	V
eous Forward Voltage teristics Capacitance acteristics Recovery Time	V <sub>R</sub> = 10 V, I <sub>F</sub> = 0	T <sub>C</sub> = 125°C	- - -	1.6		
eous Forward Voltage teristics Capacitance acteristics Recovery Time	V <sub>R</sub> = 10 V, I <sub>F</sub> = 0	T <sub>C</sub> = 125°C	- - -	1.6		
cteristics Capacitance Incteristics Recovery Time	V <sub>R</sub> = 10 V, I <sub>F</sub> = 0	T <sub>C</sub> = 125°C	-	1.6		
Capacitance Icteristics Recovery Time	I <sub>F</sub> = 1 A, di <sub>F</sub> /dt =		 	I		
Capacitance Icteristics Recovery Time	I <sub>F</sub> = 1 A, di <sub>F</sub> /dt =	A	-	19		
Recovery Time	I <sub>F</sub> = 1 A, di <sub>F</sub> /dt =	A	-	19		
Recovery Time					-	pF
Recovery Time						
		$100 \text{ A/us } V_{\rm p} = 30^{\circ}$	<u> </u>	17	20	ns
Recovery Time	$II_{r} = 4 A di_{r}/dt =$	$\frac{100 \text{ A}/\mu\text{s}}{100 \text{ A}/\mu\text{s}}$ , V <sub>R</sub> = 30 V		19	22	ns
Reverse Recovery Time	$I_F = 4 \text{ A},$	10071 µ0, 1 R 00	-	17		ns
Recovery Current	di <sub>F</sub> /dt = 200 A/μs	, V <sub>R</sub> = 390 V,	-	2.6	-	A
Recovery Charge	T <sub>C</sub> = 25°C		-	22	-	nC
Recovery Time	I <sub>F</sub> = 4 A,		-	77	-	ns
	di <sub>F</sub> /dt = 200 A/μs	di <sub>F</sub> /dt = 200 A/μs,		4.2	-	
			-	2.8	-	Α
	$I_{\rm C} = 125^{\circ}{\rm C}$		-	100	-	nC
	I <sub>F</sub> = 4 A,		-	54	-	ns
Factor (t <sub>b</sub> /t <sub>a</sub> )		3	-	3.5	-	
Recovery Current			-	4.3	-	Α
Recovery Charge	$1_{C} = 125 C$			110	-	nC
n di/dt during t <sub>b</sub>			-	500	-	A/µs
toristics						
	2000		<del></del>		2.6	°C AM
			-	-		°C/W °C/W
1	Factor $(t_b/t_a)$ Recovery Current         Recovery Charge         Recovery Time         Factor $(t_b/t_a)$ Recovery Current         Recovery Charge         n di/dt during $t_b$ teristics         Resistance Junction to C	$\label{eq:response} \begin{array}{c c} Factor (t_b/t_a) & di_F/dt = 200 \ A/\mu s \\ \hline Recovery Current & V_R = 390 \ V, \\ \hline Recovery Charge & T_C = 125^\circ C \\ \hline Recovery Time & I_F = 4 \ A, \\ \hline Factor (t_b/t_a) & di_F/dt = 400 \ A/\mu s \\ \hline Recovery Current & V_R = 390 \ V, \\ \hline Recovery Charge & T_C = 125^\circ C \\ \hline Recovery Charge & T_C = 125^\circ C \\ \hline n \ di/dt \ during \ t_b & \end{array}$	Factor (t_b/t_a)diF/dt = 200 A/ $\mu$ s, VR = 390 V, TC = 125°CRecovery ChargeTC = 125°CRecovery TimeIF = 4 A, diF/dt = 400 A/ $\mu$ s, VR = 390 V, TC = 125°CFactor (t_b/t_a)diF/dt = 400 A/ $\mu$ s, VR = 390 V, TC = 125°CRecovery CurrentTC = 125°CRecovery ChargeTC = 125°Cn di/dt during t_bTC = 125°CteristicsResistance Junction to Case	$\begin{tabular}{ c c c c c c c } \hline Factor (t_b/t_a) & di_F/dt = 200 \ A/\mu s, & & - & & & & & & & & & & & & & & & & $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $



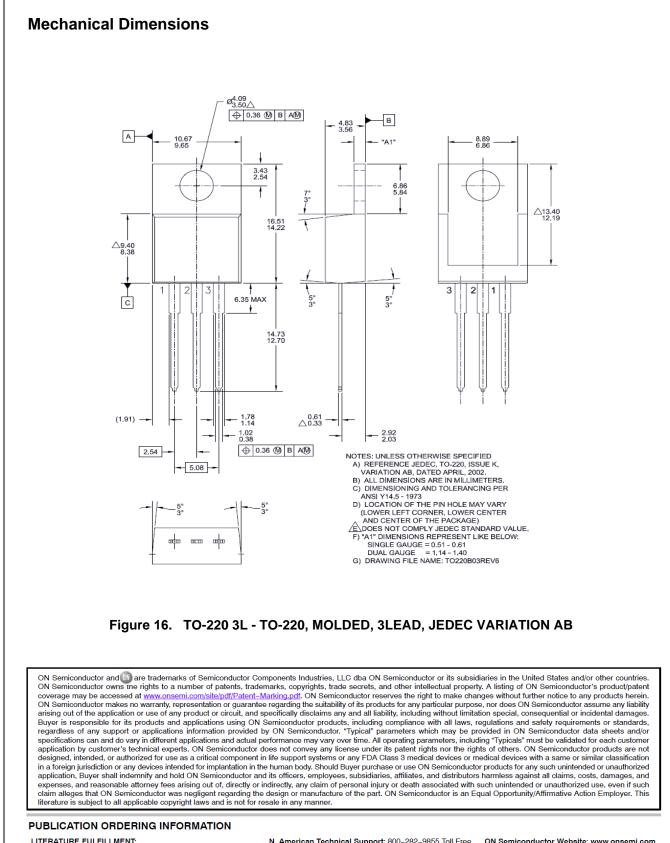
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